



SYS-CLEAN MC1.0 - concentrate

MAINTENANCE CLEANER

SYS-CLEAN MC1.0 – concentrate is a water-based, alkaline cleaning agent for cleaning soldering frames and devices, furnace parts and filters at room temperature.

SYS-CLEAN MC1.0 – concentrate reliably cleans burnt flux residue, and oils and fats.

The most stubborn dirt is removed by **SYS-CLEAN MC1.0 – concentrate** even at short contact times and lower application temperature.

Application

Pollution	Suitability
Lead-containing flux	✓✓
Lead-free flux	✓✓
Water soluble flux	✓✓
Solder paste	✓✓
Oil/Fat	✓

Application Parameters

Parameter	
Application temperature	20-40°C
Cleaning duration approx	8-15min.
Rinsing	DI-Water
Drying	Convection/ Compressed Air
Application concentration	15%-25%

Specifications

SYS-CLEAN MC1.0 – concentrate (also available as ready-to-use).

Density	1 g/cm ³
Boiling point	> 100°C
Flashpoint	not applicable
pH value	11,8



SYS-CLEAN MC1.0 - concentrate

Advantages: **SYS-CLEAN MC1.0 – concentrate** is best suited for cleaning soldering frames and devices, as well as furnace parts and filters. The cleaner is virtually odorless. Due to the very high loading capacity and good filterability a cost efficient process is ensured.

SYS-CLEAN MC1.0 – concentrate is formulated including a defoamer and is very gentle for cleaning plastic and aluminum parts.

The concentrate offers in contrast to the ready-to-use version, the possibility to adapt the concentration to your needs. (ready-to-use = 20% concentration)

Type of application: Spray in air / spray under immersion / ultrasonic

Purity Standards: **SYS-CLEAN MC1.0 – concentrate** is water-based and biodegradable.

Safety: Please note the information in the MSDS.

Disposal: If required, we will take back used medium and undertake the disposal for you.

Availability: **SYS-CLEAN MC1.0 - concentrate** is available in pack sizes of 25 or 200 liters.



The product is free of questionable ingredients in accordance with the SIN & SVHC lists



100% compliant with the EU RoHS directive 1 & 2, WEEE